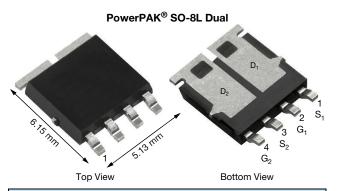
SQJ500AEP

ISHA www.vishay.com

Vishay Siliconix

Automotive N- and P-Channel 40 V (D-S) 175 °C MOSFET



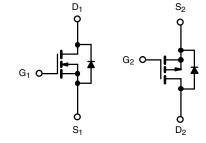
PRODUCT SUMMAR	ODUCT SUMMARY					
	N-CHANNEL	P-CHANNEL				
V _{DS} (V)	40	-40				
$R_{DS(on)}\left(\Omega\right)$ at $V_{GS}=\pm$ 10 V	0.0092	0.0270				
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 4.5 \text{ V}$	0.0112	0.0435				
I _D (A)	30	-30				
Configuration	N- and	l p-pair				

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified d
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE



N-Channel MOSFET P-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ500AEP (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS (T _C =	= 25 °C, unless	otherwise n	oted)		
PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-source voltage		V _{DS}	40	-40	v
Gate-source voltage		V _{GS}	±	v	
Continuous drain current ^a	T _C = 25 °C	I	30	-30	
	T _C = 125 °C	ID	30	-18	A
Continuous source current (diode conduction) ^a		I _S	30	-30	А
Pulsed drain current ^b		I _{DM}	120	-120	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	26.5	-25	
Single pulse avalanche energy	L = 0.1 mm	E _{AS}	35	31	mJ
Maximum power dissipation ^b	T _C = 25 °C	Р	48	48	w
Maximum power dissipation -	n power dissipation ^b $T_C = 125 \ ^{\circ}C$ P_D 16 16	vv			
Operating junction and storage temperature range T _J , T _{stg} -55 to +175					
Soldering recommendations (peak temperature) e, f			26	60	°C

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Junction-to-ambient	PCB mount c	R _{thJA}	85	85	°C/W
Junction-to-case (drain)		R _{thJC}	3.1	3.1	

Notes

a. Package limited

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. When mounted on 1" square PCB (FR4 material)

d. Parametric verification ongoing

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed e. and is not required to ensure adequate bottom side solder interconnection

1

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components f.

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Gate resistance

Document Number: 62878

2.1

9.5

		$V_{GS} = 0 V$	V _{DS} = -40 V	P-Ch	-	-	-1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	N-Ch	-	-	50	
		$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	P-Ch	-	-	-50	
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	N-Ch	-	-	150	
		$V_{GS} = 0 V$	$V_{DS} = -40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	P-Ch	-	-	-150	
On state drain ourrent à	1	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	N-Ch	25	-	-	
Zero gate voltage drain current $V_{GS} = 0 V$ $V_{DS} = 40 V$, $T_J = 125 °C$ N-Ch - $V_{GS} = 0 V$ $V_{DS} = -40 V$, $T_J = 125 °C$ P-Ch - $V_{GS} = 0 V$ $V_{DS} = -40 V$, $T_J = 125 °C$ P-Ch - $V_{GS} = 0 V$ $V_{DS} = -40 V$, $T_J = 175 °C$ N-Ch - $V_{GS} = 0 V$ $V_{DS} = -40 V$, $T_J = 175 °C$ N-Ch - $V_{GS} = 0 V$ $V_{DS} = -40 V$, $T_J = 175 °C$ P-Ch -		-	-					
		$V_{GS} = 10 V$	I _D = 9.8 A	N-Ch	-	0.0077	0.0092	
		V _{GS} = -10 V	I _D = -6 A	P-Ch	-	0.0220	0.0270	
		V _{GS} = 10 V	I _D = 9.8 A, T _J = 125 °C	N-Ch	-	-	0.0138	
Zero gate voltage drain current I_{DSS} $V_{GS} = 0$ $V_{GS} = 0$ $V_{GS} = 0$ $V_{GS} = 0$ On-state drain current a $I_{D(on)}$ $V_{GS} = 10$ $V_{GS} = -10$ Drain-source on-state resistance a $V_{GS} = -10$ $V_{GS} = -10$ Drain-source on-state resistance a $V_{GS} = -10$ $V_{GS} = -10$ $V_{GS} = -10$ Drain-source on-state resistance b Q_{fS} Drain-source on-state resistance b Q_{fS} $V_{GS} = -10$ $V_{GS} = -10$ $V_{GS} = 0$ $Output$ capacitance C_{rss} $V_{GS} = 0$ <tr< td=""><td>_</td><td>$V_{GS} = -10 V$</td><td>I_D = -6 A, T_J = 125 °C</td><td>P-Ch</td><td>-</td><td>-</td><td>0.0380</td><td></td></tr<>	_	$V_{GS} = -10 V$	I _D = -6 A, T _J = 125 °C	P-Ch	-	-	0.0380	
	DS(on)	V _{GS} = 10 V	I _D = 9.8 A, T _J = 175 °C	N-Ch	-	-	0.0170	
	$V_{GS} = -10 V$	I _D = -6 A, T _J = 175 °C	P-Ch	-	-	0.0460		
		$V_{GS} = 4.5 V$	I _D = 8.9 A	N-Ch	-	0.0094	0.0112	
		V _{GS} = -4.5 V	I _D = -4.7 A	P-Ch	-	0.0360	0.0435	
Forward transponductorsa b		V _{DS} =	= 15 V, I _D = 9.8 A	N-Ch	-	65	-	
Forward transconductance ~	9fs	V _{DS} =	= -15 V, I _D = -6 A	P-Ch	-	16	-	
Dynamic ^b								
	C	$V_{GS} = 0 V$	V_{DS} = 20 V, f = 1 MHz	N-Ch	-	1474	1843	
input capacitance	Uiss	$V_{GS} = 0 V$	V_{DS} = -20 V, f = 1 MHz	P-Ch	-	1302	1628	
	C	$V_{GS} = 0 V$	V_{DS} = 20 V, f = 1 MHz	N-Ch	-	218	273	
Output capacitance	U _{OSS}	$V_{GS} = 0 V$	V _{DS} = -20 V, f = 1 MHz	P-Ch	-	222	278	
Poverse transfer especitance	0	$V_{GS} = 0 V$	V_{DS} = 20 V, f = 1 MHz	N-Ch	-	89	111	
neverse transfer capacitance	Urss	$V_{GS} = 0 V$	V _{DS} = -20 V, f = 1 MHz	P-Ch	-	154	193	
Total gata abarga 6	0	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, I_D = 10 \text{ A}$	N-Ch	-	25.5	38.3	
Total gate charge	Qq	$V_{cc} = -10 V$	$V_{DS} = -20 V_{.} I_{D} = -10 A$	P-Ch	-	30.2	45	
	0	VGS = 10 V	• 03 =• •, 0					
Cata source charge 6	Value V _{GS} = 10 V V _{DS} = 20 V, I _D = 10 A N-Ch - 25.5 38.3 V _{GS} = -10 V V _{DS} = -20 V, I _D = -10 A P-Ch - 30.2 45 V _{GS} = 10 V V _{DS} = 20 V, I _D = 10 A N-Ch - 4.4 -							
Gate-source charge ^c				N-Ch P-Ch	-	4.4 4.1	-	I
	Q _{gs}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 10 A					1
Gate-source charge ^c Gate-drain charge ^c		V _{GS} = 10 V V _{GS} = -10 V	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $V_{DS} = -20 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	P-Ch	-	4.1	-	

TEST CONDITIONS

 $V_{DS} = 40 V$

 $V_{GS} = 0 V, I_D = 250 \mu A$

 V_{GS} = 0 V, I_D = -250 μ A

 $V_{DS}=V_{GS},\,I_{D}=250\;\mu A$

 $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$

 $V_{DS} = 0 V, V_{GS} = \pm 20 V$

 $V_{GS} = 0 V$

Drain-source breakdown voltage

Gate-source threshold voltage

Gate-source leakage

PARAMETER

Static

SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)

SYMBOL

 V_{DS}

V_{GS(th)}

I_{GSS}

 R_g

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MAX.

-

_

2.3

-2.5

± 100

± 100

1

UNIT

۷

nA

μΑ

А

Ω

S

рF

nC

Ω

MIN.

40

-40

1.3

-1.5

-

_

-

N-Ch

P-Ch

N-Ch

P-Ch

N-Ch

P-Ch

N-Ch

N-Ch

P-Ch

0.65

3.1

1.37

6.15

TYP.

-

_

1.8

-2

-

_

-

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f = 1 MHz

2



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SQJ500AEP

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SPECIFICATIONS (T _C :	= 25 °C, unless o	otherwise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Dynamic ^b							
Turn-on delay time ^c	+	$\label{eq:VDD} \begin{array}{l} V_{DD} = 20 \text{ V}, \text{R}_{\text{L}} = 2 \Omega \\ \text{I}_{\text{D}} \cong 10 \text{A}, \text{V}_{\text{GEN}} = 10 \text{V}, \text{R}_{\text{g}} = 1 \Omega \end{array}$	N-Ch	-	8	12	
rum-on delay time *	t _{d(on)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = \text{-20 V, } R_L = 2 \ \Omega \\ I_D \cong \text{-10 A, } V_GEN = \text{-10 V, } R_g = 1 \ \Omega \end{array}$	P-Ch	-	7	11	
		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	12	18	
Rise time ^c	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{-20 V, } R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong \text{-10 A, } V_{\text{GEN}} = \text{-10 V, } R_{\text{g}} = 1 \ \Omega \end{array}$	P-Ch	-	9	13	
T (()) ()	+	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	22	33	ns
Turn-off delay time ^c	t _{d(off)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = \text{-20 V, } R_L = 2 \ \Omega \\ I_D \cong \text{-10 A, } V_GEN = \text{-10 V, } R_g = 1 \ \Omega \end{array}$	P-Ch	-	43	64	
Fall time 6	+	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 20 \text{ V}, \ R_{\text{L}} = 2 \ \Omega \\ I_{\text{D}} \cong 10 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch	-	10	16	
Fall time ^c t _f	۲f	$\label{eq:VDD} \begin{array}{l} V_{DD} = \text{-20 V, } R_L = 2 \ \Omega \\ I_D \cong \text{-10 A, } V_GEN = \text{-10 V, } R_g = 1 \ \Omega \end{array}$	P-Ch	-	19	28	
Source-Drain Diode Ratings	and Characteristics	5 b					
Pulsed current ^a			N-Ch	-	-	120	А
	I _{SM}		P-Ch	-	-	-120	~
Forward voltage	N _e -	I _S = 6.5 A	N-Ch	-	0.79	1.2	v
i orward voltage	V _{SD}	I _S = -3.4 A	P-Ch	-	-0.78	-1.2	Ň

Notes

g. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty}~\text{cycle} \leq 2~\%$

h. Guaranteed by design, not subject to production testing

i. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

3

SQJ500AEP



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Tc

 $T_C =$ - 55 °C

T_C = 125 °C

16

Ciss

32

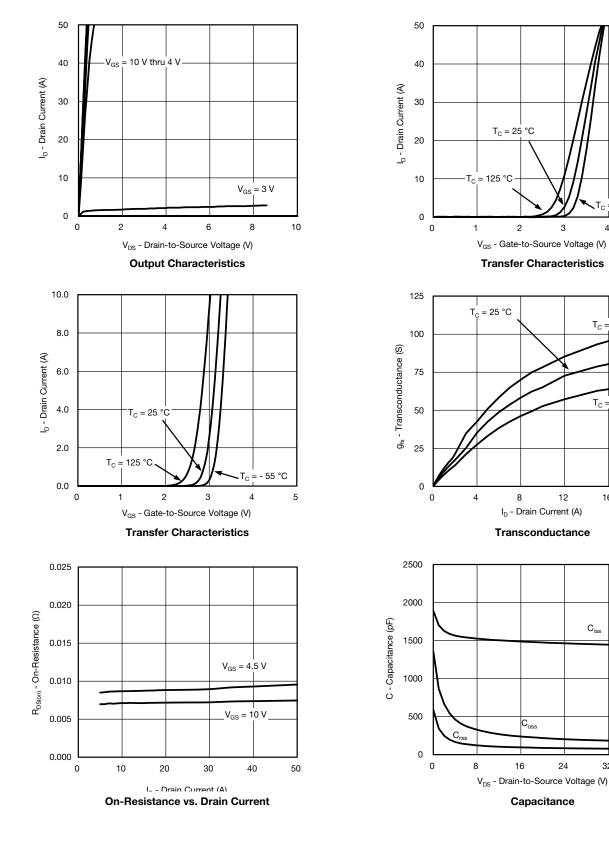
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4

- 55 °C

5

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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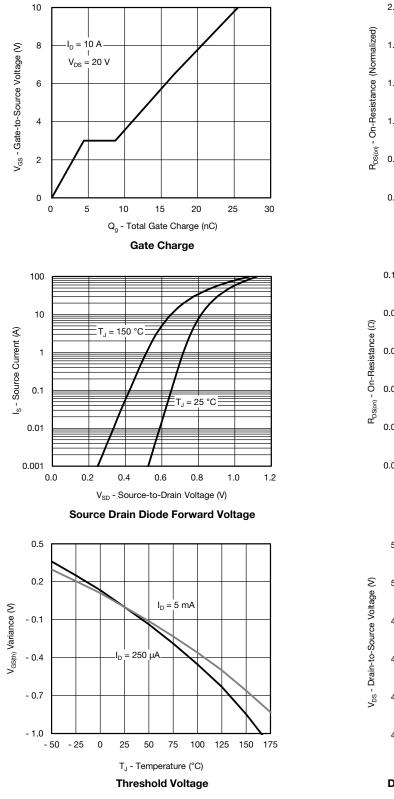
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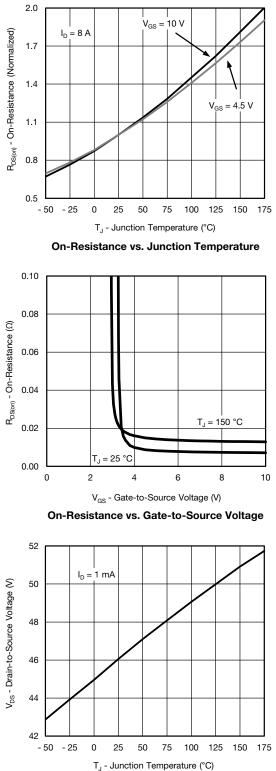
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N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





Drain Source Breakdown vs. Junction Temperature

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5

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2 1

0.1

0.01

10-3

0.05

0.02

1

Single Pulse

10-2

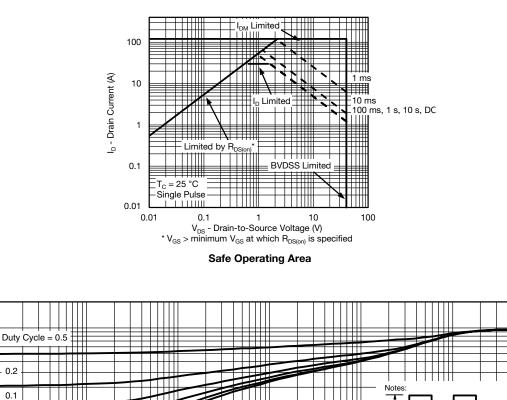
Nomalized Effective Transient Thermal Impedance

SQJ500AEP

Vishay Siliconix

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

10-1



1

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient

ŧ P_{DM}

10

t₁ Ŀ

1. Duty Cycle, D =

4. Surface Mounted

t₂

3. T_{JM} - $T_A = P_{DM}Z_{thJA}^{(t)}$

<u>t_</u>

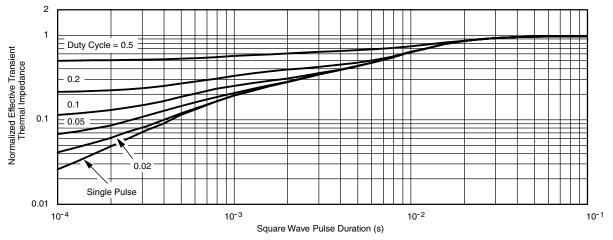
t₂ 2. Per Unit Base = R_{thJA} = 85 °C/W

600

100



N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

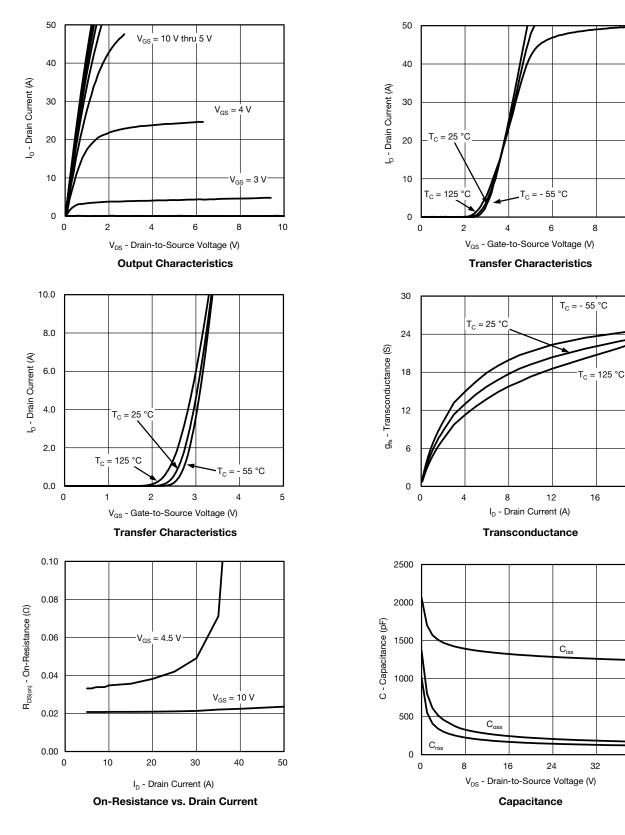
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



10

20

P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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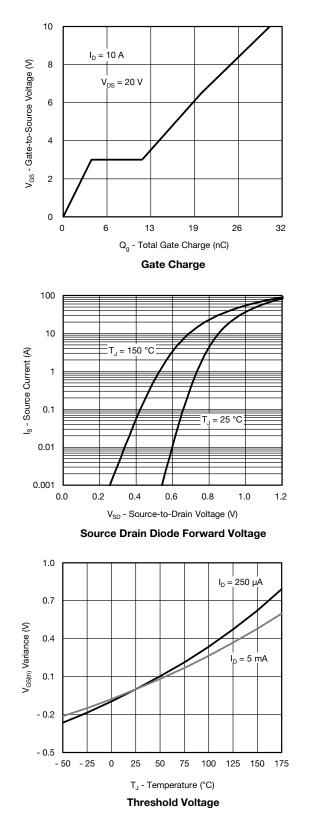
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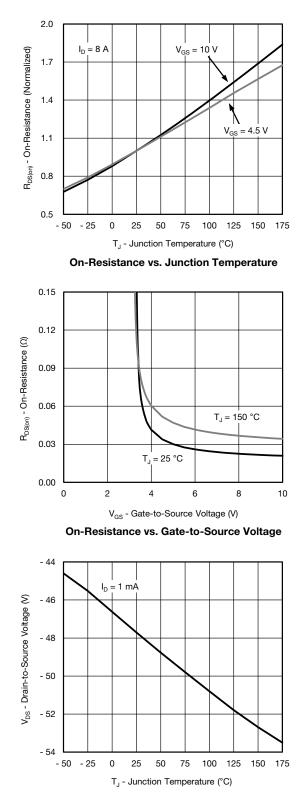
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P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Drain Source Breakdown vs. Junction Temperature

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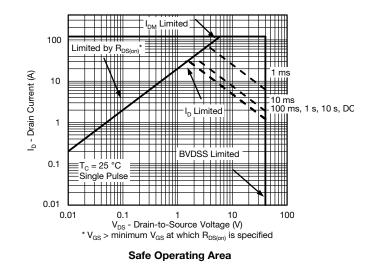
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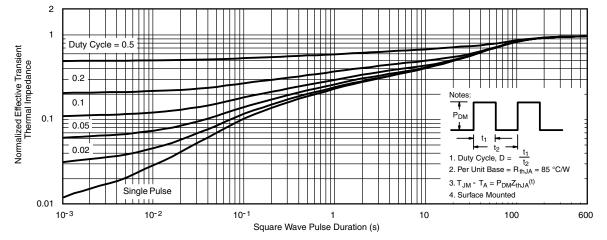
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P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

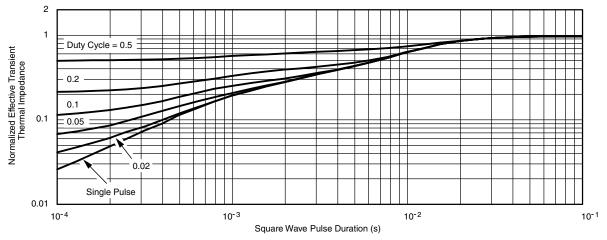




Normalized Thermal Transient Impedance, Junction-to-Ambient



P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

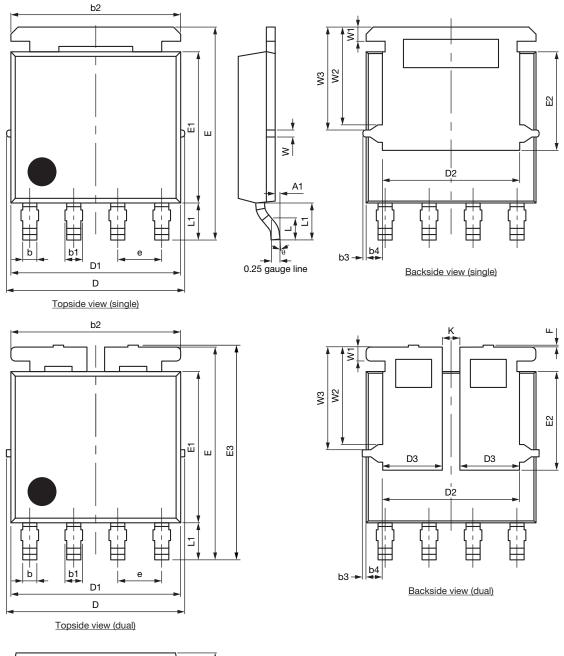
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

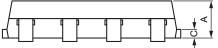
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62878.









Package Information



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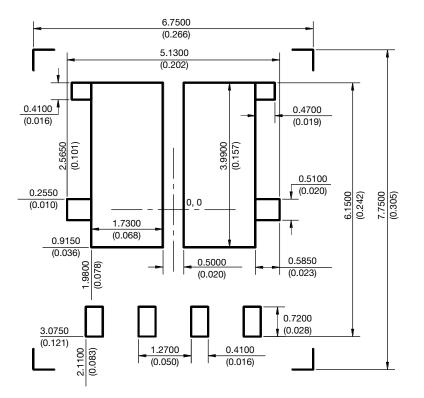
DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	·		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC	·		0.050 BSC		
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	6.05	6.22	6.40	0.238	0.245	0.252	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51	·		0.020		
W		0.23			0.009		
W1		0.41			0.016		
W2		2.82			0.111		
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads Dimensions in mm (inches) Keep-out 6.75 (0.266) x 7.75 (0.305)

Revision: 07-Feb-12



Vishay

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